

#### **Features**

- Small Body Outline Dimensions
- Low Body Height
- Stand-off Voltage: 2.5 V 12 V
- Peak Power up to 200 Watts @ 8 x 20 \_s Pulse
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human
   Body Model
- IEC61000-4-2 Level 4 ESD Protection
- IEC61000-4-4 Level 4 EFT Protection
- We declare that the material of product compliance with RoHS requirements
- S-Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

## **ORDERING INFORMATION**

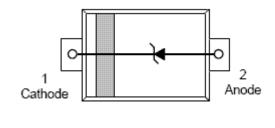
Device	Package	Shipping		
LXESD5Z2.5-12V	SOD-523	3000/Tape & Reel		

### **Applications**

- Cellular phones
- Portable devices
- Digital cameras
- Power supplies

## **General Description**

The LXESD5Z3.3-12V Series is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.



SOD-523

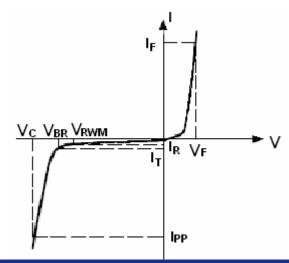
# Absolute Ratings (T<sub>amb</sub>=25°C)

Symbol	Parameter	Value	Units
P <sub>PP</sub>	Peak Pulse Power (t <sub>p</sub> = 8/20μs)	200	W
TL	Maximum lead temperature for soldering during 10s	260	°C
$T_{stg}$	Storage Temperature Range	-55 to +150	°C
T <sub>op</sub>	Operating Temperature Range	-40 to +125	°C
Tj	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD)  air discharge  contact discharge	±25 ±25	KV
	IEC61000-4-4 (EFT)	40	Α
	ESD Voltage Per Human Body Model	16	KV



# **Electrical Parameter**

Symbol	Parameter			
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current			
Vc	Clamping Voltage @ IPP			
V <sub>RWM</sub>	Working Peak Reverse Voltage			
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>			
ŀг	Test Current			
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>			
l <sub>F</sub>	Forward Current			
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>			



Electrical Characteristics Ratings at 25° C ambient temperature unless otherwise specified.VF = 0.9V at IF = 10mA

Device	Device Marking	V <sub>RWM</sub> (V)	I <sub>R</sub> (uA) @ V <sub>RWM</sub>	V <sub>BR</sub> (V)@ I <sub>T</sub> (Note 1)	ŀr	V <sub>c</sub> (V) @ I <sub>PP</sub> =5 A*	V <sub>C</sub> (V) @ Max I <sub>PP</sub> *	I <sub>PP</sub> (A)*	P <sub>PK</sub> (W)*	C (pF)
		Max	Max	Min	mA	Тур	Max	Max	Max	Тур
LXESD5Z2.5	ZD	2.5	6.0	4.0	1.0	6.5	10.9	11.0	120	145
LXESD5Z3.3	ZE	3.3	1.0	5.0	1.0	8.4	14.1	11.2	158	105
LXESD5Z5.0	ZF	5.0	1.0	6.2	1.0	11.6	18.6	9.4	174	80
LXESD5Z6.0	ZG	6.0	1.0	6.8	1.0	12.4	20.5	8.8	181	70
LXESD5Z7.0	ZH	7.0	1.0	7.5	1.0	13.5	22.7	8.8	200	65
LXESD5Z12	ZM	12	1.0	13.5	1.0	17	25	9.6	240	55

<sup>\*</sup>Surge current waveform per Figure 1.

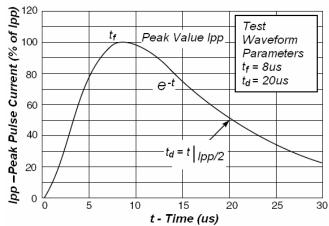


Fig1. Pulse Waveform

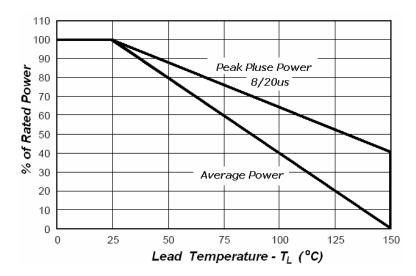


Fig3.Power Derating

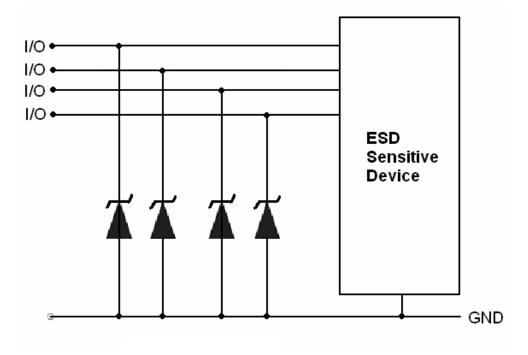
### **Application Note**

Electrostatic discharge (ESD) is a major cause of failure in electronic systems. Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient to a low enough level such that damage to the protected semiconductor is prevented.

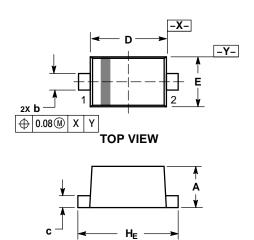
Surface mount TVS offer the best choice for minimal lead inductance. They serve as parallel protection elements, connected between the signal line to ground. As the transient rises above the operating voltage of the device, the TVS — becomes a low impedance path diverting the transient current to ground. The PESD5Z2.5 is the ideal board evel protection of ESD sensitive semiconductor components.

The tiny SOD523 package allows design flexibility in the design of high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening againt ESD.



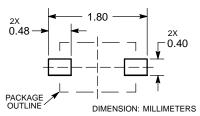


SC-79/SOD-523





**SIDE VIEW** 



#### NOTES:

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  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
  MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
  BASE MATERIAL.
  4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS						
DIM	MIN	NOM	MAX				
Α	0.50	0.60	0.70				
b	0.25	0.30	0.35				
С	0.07	0.14	0.20				
D	1.10	1.20	1.30				
E	0.70	0.80	0.90				
HE	1.50	1.60	1.70				
L	0.30 REF						
L2	0.15 0.20 0.25						